

Technical Data
Data Sheet N1209, Rev. C

Green Products

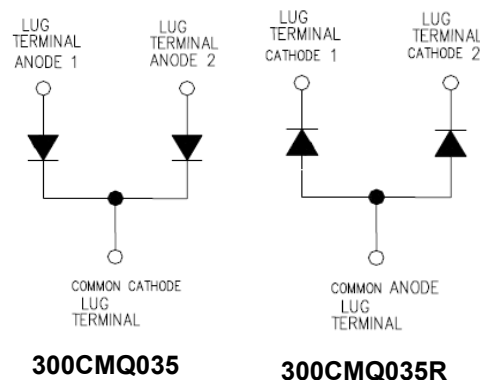
300CMQ... SERIES SCHOTTKY RECTIFIER

Applications:

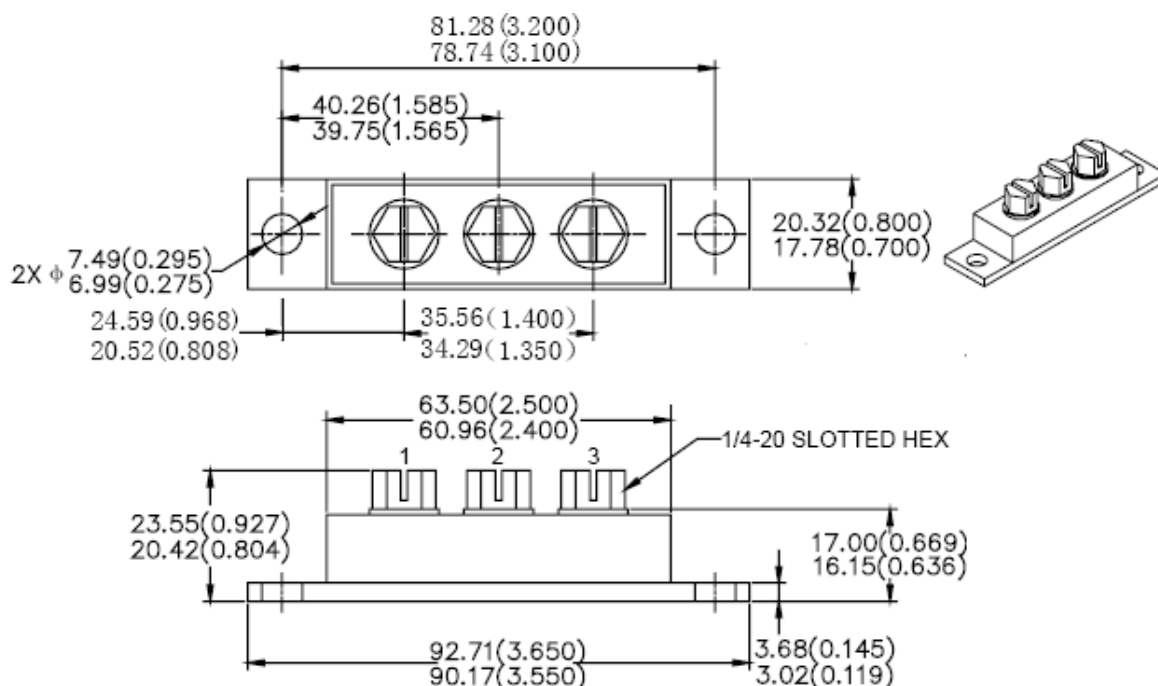
- High current switching power supply • Plating power supply • Free-Wheeling diodes
- Reverse battery protection • Converters • UPS System • Welding

Features:

- 150 °C T_J operation
- Center tap module
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request



Mechanical Dimensions: In mm/Inches



Please Note: Suffix "R" Denotes For Reversed Polarity
PRM4 (Isolated)

MARKING, MOLDING RESIN

Marking for 300CMQ035/R, 1st row SS YYWWL, 2nd row 300CMQ035/300CMQ035R

Where YY is the manufacture year

WW is the manufacture week code

L is the wafer's Lot Number

Molding resin

Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units
Peak Inverse Voltage	V_{RWM}	-	35	300CMQ035/R	V
			40	300CMQ040/R	
			45	300CMQ045/R	
Max. Average Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_C = 104^\circ\text{C}$, rectangular wave form	150	per leg	A
			300	per device	
Max. Peak One Cycle Non-Repetitive Surge Current (per leg)	I_{FSM}	8.3 ms, half Sine pulse	2880		A
Non-Repetitive Avalanche Energy(per leg)	E_{AS}	$T_J = 25^\circ\text{C}$, $I_{AS} = 30\text{A}$, $L = 0.67\text{mH}$	150		mJ
Repetitive Avalanche Current(per leg)	I_{AR}	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. $V_A = 1.5 \times V_R$ typical	30		A

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 150A, Pulse, $T_J = 25^\circ\text{C}$	0.61	V
		@ 300A, Pulse, $T_J = 25^\circ\text{C}$	0.77	
	V_{F2}	@ 150A, Pulse, $T_J = 125^\circ\text{C}$	0.62	V
		@ 300A, Pulse, $T_J = 125^\circ\text{C}$	0.75	
Max. Reverse Current (per leg) *	I_{R1}	@ $V_R = \text{rated } V_R$ $T_J = 25^\circ\text{C}$	15	mA
	I_{R2}	@ $V_R = \text{rated } V_R$ $T_J = 125^\circ\text{C}$	750	
Max. Junction Capacitance (per leg)	C_T	@ $V_R = 5\text{V}$, $T_C = 25^\circ\text{C}$ $f_{\text{SIG}} = 1\text{MHz}$	7750	pF
Typical Series Inductance (per leg)	L_S	Measured lead to lead 5 mm from package body	6.0	nH
Max. Voltage Rate of Change	dv/dt	-	10,000	V/ μs

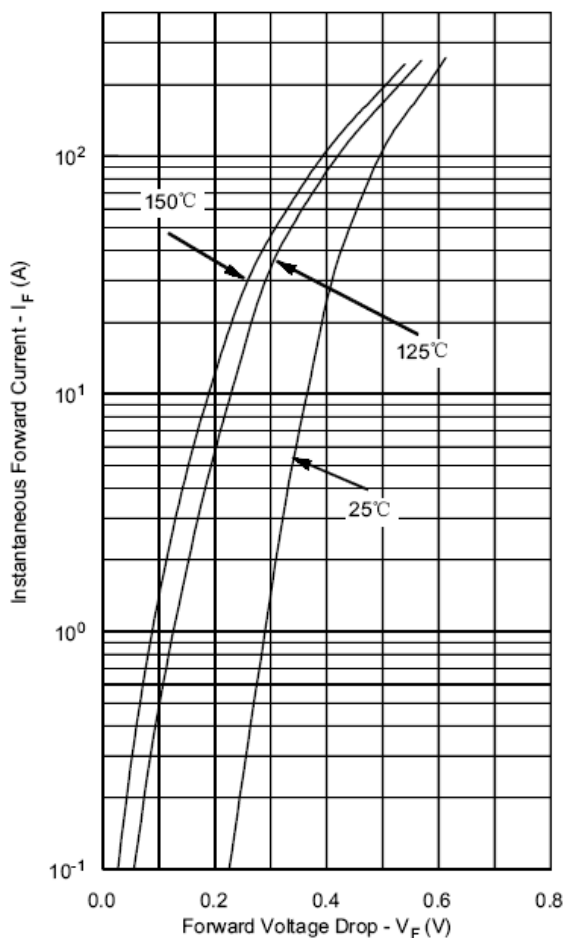
* Pulse Width < 300 μs , Duty Cycle < 2%

Thermal-Mechanical Specifications:

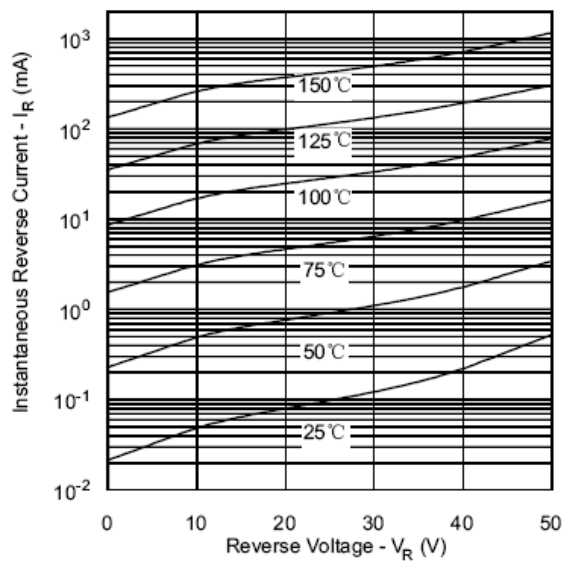
Characteristics	Symbol	Condition	Specification		Units
Max. Junction Temperature	T _J	-	-55 to +150		°C
Max. Storage Temperature	T _{stg}	-	-55 to +150		°C
Maximum Thermal Resistance Junction to Case (per leg)	R _{θJC}	DC operation	0.50		°C/W
Maximum Thermal Resistance Junction to Case (per package)	R _{θJC}	DC operation	0.25		°C/W
Typical Thermal Resistance, case to Heat Sink	R _{θcs}	Mounting surface, smooth and greased	0.10		°C/W
Mounting Torque	T _M	-	Mounting Torque	24(min) 35(max)	Kg-cm
			Terminal Torque	35(min) 46(max)	
Approximate Weight	wt	-	79		g
Case Style	PRM4 Isolated				

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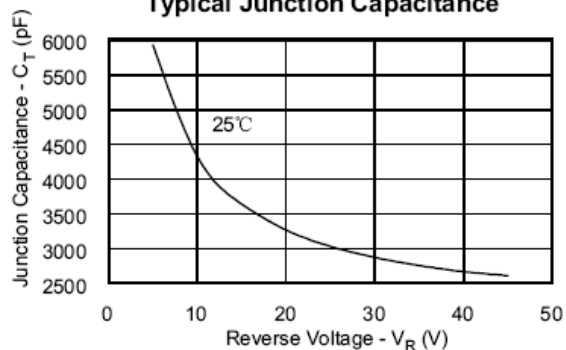
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance



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